



## 2.5Ω, Low-Voltage, SPST/SPDT Analog Switches in UCSP Package

### General Description

The MAX4686/MAX4687/MAX4688 low on-resistance ( $R_{ON}$ ), low-voltage analog switches operate from a single +1.8V to +5.5V supply. The MAX4686/MAX4687 are single-pole/single-throw (SPST) analog switches, and the MAX4688 is a single-pole/double-throw (SPDT) analog switch. The MAX4686 is a normally open (NO) switch, and the MAX4687 is a normally closed (NC) switch. The MAX4688 has one normally open (NO) switch and one normally closed (NC) switch.

When powered from a 3V supply these devices feature 2.5Ω (max)  $R_{ON}$ , with 0.4Ω (max)  $R_{ON}$  matching and 1Ω (max) flatness. The MAX4686/MAX4687/MAX4688 offer fast switching speeds ( $t_{ON} = 30\text{ns}$  max,  $t_{OFF} = 12\text{ns}$  max). The MAX4688 offers break-before-make action.

The digital logic inputs are 1.8V logic compatible from a +2.7V to +3.3V supply. The MAX4686/MAX4687/MAX4688 are available in the chip-scale package (UCSP™), significantly reducing the required PC board area. The chip occupies only a 1.50mm x 1.02mm area. The 3 x 2 array of solder bumps are spaced with a 0.5mm bump pitch.

### Applications

MP3 Players  
Cellular Phones  
Power Routing  
Battery-Operated Equipment  
Relay Replacement  
Audio and Video Signal Routing  
Communications Circuits  
PCMCIA Cards  
Cellular Phones  
Hard Drives

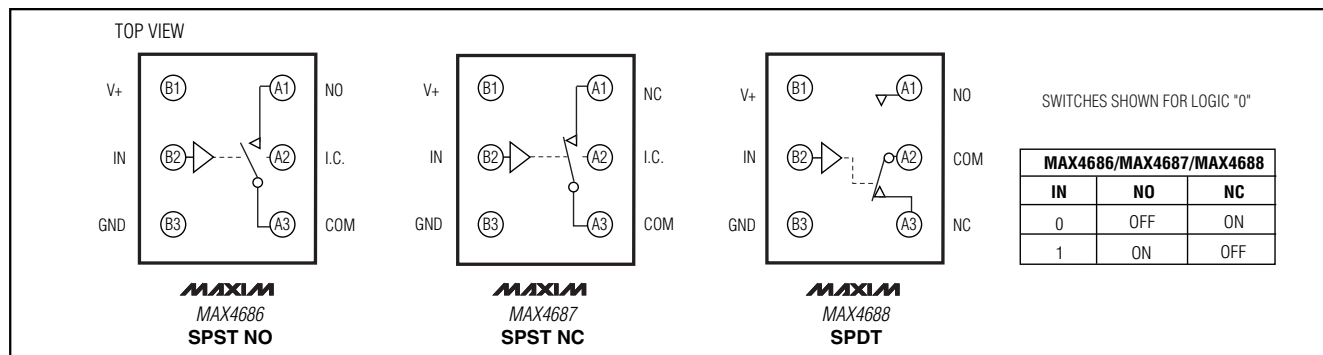
### Features

- ◆ 6-Bump, 0.5mm Pitch, UCSP
- ◆  $R_{ON}$   
2.5Ω max (+3V Supply)  
10Ω max (+1.8V Supply)
- ◆ 0.4Ω max  $R_{ON}$  Match Between Channels
- ◆ 1Ω max  $R_{ON}$  Flatness Over Signal Range
- ◆ Low Leakage Currents Over Temperature  
0.5nA (max) at  $T_A = +25^\circ\text{C}$
- ◆ Fast Switching:  $t_{ON} = 30\text{ns}$ ,  $t_{OFF} = 12\text{ns}$
- ◆ Guaranteed Break-Before-Make (MAX4688)
- ◆ +1.8V to +5.5V Single-Supply Operation
- ◆ Rail-to-Rail® Signal Handling
- ◆ Low Crosstalk: -95dB (100kHz)
- ◆ High Off-Isolation: -90dB (100kHz)
- ◆ 1.8V Logic Compatible

### Ordering Information

| PART         | TEMP RANGE     | BUMP-PACKAGE | TOP MARK |
|--------------|----------------|--------------|----------|
| MAX4686EBT-T | -40°C to +85°C | 6 UCSP-6     | AAI      |
| MAX4687EBT-T | -40°C to +85°C | 6 UCSP-6     | AAJ      |
| MAX4688EBT-T | -40°C to +85°C | 6 UCSP-6     | AAK      |

### Pin Configurations/Functional Diagrams/Truth Table



Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd.

UCSP is a trademark of Maxim Integrated Products, Inc.



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**For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at [www.maxim-ic.com](http://www.maxim-ic.com).**

MAX4686/MAX4687/MAX4688

# 2.5Ω, Low-Voltage, SPST/SPDT Analog Switches in UCSP Package

## ABSOLUTE MAXIMUM RATINGS

All Voltages Referenced to GND

V+, IN .....-0.3V to +6V  
 COM, NO, NC (Note1).....-0.3V to (V+ + 0.3V)  
 Continuous Current NO, NC, COM .....±100mA  
 Peak Current NO, NC, COM  
 (pulsed at 1ms, 10% duty cycle) .....±200mA

Continuous Power Dissipation (T<sub>A</sub> = +70°C)

3 x 2 UCSP (derate 10.1mW/°C at +70°C) .....808mW

Operating Temperature Range .....-40°C to +85°C

Storage Temperature Range .....-65°C to +150°C

Bump Reflow Temperature .....+235°C

**Note 1:** Signals on NO, NC, and COM exceeding V+ are clamped by an internal diode. Limit forward-diode current to maximum current rating.

**Note 2:** This device is constructed using a unique set of packaging techniques that impose a limit on the thermal profile the device can be exposed to during board level solder attach and rework. This limit permits only the use of the solder profiles recommended in the industry standard specification, JEDEC 020A, paragraph 7.6, Table 3 for IR/VPR and convection reflow. Preheating is required. Hand or wave soldering is not allowed.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

(V+ = +2.7V to +3.3V, V<sub>IH</sub> = +1.4V, V<sub>IL</sub> = 0.5V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at 3V and T<sub>A</sub> = +25°C.) (Notes 3, 4)

| PARAMETER                                                    | SYMBOL                                               | CONDITIONS                                                                                           | T <sub>A</sub>                       | MIN  | TYP   | MAX  | UNITS |
|--------------------------------------------------------------|------------------------------------------------------|------------------------------------------------------------------------------------------------------|--------------------------------------|------|-------|------|-------|
| ANALOG SWITCH                                                |                                                      |                                                                                                      |                                      |      |       |      |       |
| Analog Signal Range                                          | V <sub>COM</sub> , V <sub>NO</sub> , V <sub>NC</sub> |                                                                                                      | T <sub>MIN</sub> to T <sub>MAX</sub> | 0    |       | V+   | V     |
| On-Resistance                                                | R <sub>ON</sub>                                      | V+ = 2.7V, V <sub>NC</sub> = 0 to V+, I <sub>COM</sub> = 10mA                                        | +25°C                                | 1.5  | 2.5   | Ω    |       |
|                                                              |                                                      |                                                                                                      | T <sub>MIN</sub> to T <sub>MAX</sub> | 3.5  |       |      |       |
| On-Resistance Match Between Channels (MAX4688 only) (Note 5) | ΔR <sub>ON</sub>                                     | V+ = 2.7V, V <sub>NO</sub> or V <sub>NC</sub> = 1.5V, I <sub>COM</sub> = 10mA                        | +25°C                                | 0.3  | 0.4   | Ω    |       |
|                                                              |                                                      |                                                                                                      | T <sub>MIN</sub> to T <sub>MAX</sub> | 0.5  |       |      |       |
| On-Resistance Flatness (Note 6)                              | R <sub>FLAT(ON)</sub>                                | V+ = 2.7V, V <sub>NO</sub> or V <sub>NC</sub> = 0 to V+, I <sub>COM</sub> = 10mA                     | +25°C                                | 0.5  | 1     | Ω    |       |
|                                                              |                                                      |                                                                                                      | T <sub>MIN</sub> to T <sub>MAX</sub> | 1    |       |      |       |
| NO, NC Off-Leakage Current (Note 7)                          | I <sub>NO(OFF)</sub> , I <sub>NC(OFF)</sub>          | V+ = 3.3V; V <sub>COM</sub> = 0.3V or 3V; V <sub>NO</sub> or V <sub>NC</sub> = 3V, 0.3V              | +25°C                                | -0.5 | ±0.01 | +0.5 | nA    |
|                                                              |                                                      |                                                                                                      | T <sub>MIN</sub> to T <sub>MAX</sub> | -1   | 1     |      |       |
| COM Off-Leakage Current (Note 7)                             | I <sub>COM_(OFF)</sub>                               | V+ = 3.3V; V <sub>COM</sub> = 0.3V or 3V; V <sub>NO</sub> or V <sub>NC</sub> = 3V, 0.3V              | +25°C                                | -0.5 | ±0.01 | 0.5  | nA    |
|                                                              |                                                      |                                                                                                      | T <sub>MIN</sub> to T <sub>MAX</sub> | -1   | 1     |      |       |
| COM On-Leakage Current (Note 7)                              | I <sub>COM_(ON)</sub>                                | V+ = 3.3V; V <sub>COM</sub> = 3V or 0.3V; V <sub>NO</sub> or V <sub>NC</sub> = 3V, 0.3V, or floating | +25°C                                | -0.5 | ±0.01 | 0.5  | nA    |
|                                                              |                                                      |                                                                                                      | T <sub>MIN</sub> to T <sub>MAX</sub> | -1   | 1     |      |       |
| DYNAMIC CHARACTERISTICS                                      |                                                      |                                                                                                      |                                      |      |       |      |       |
| Turn-On Time (Note 7)                                        | t <sub>ON</sub>                                      | V <sub>NO</sub> or V <sub>NC</sub> = 1.5V, Figure 2                                                  | +25°C                                | 20   | 30    | ns   |       |
|                                                              |                                                      |                                                                                                      | T <sub>MIN</sub> to T <sub>MAX</sub> | 35   |       |      |       |

# 2.5Ω, Low-Voltage, SPST/SPDT Analog Switches in UCSP Package

MAX4686/MAX4687/MAX4688

## ELECTRICAL CHARACTERISTICS (continued)

(V<sub>+</sub> = +2.7V to +3.3V, V<sub>IH</sub> = +1.4V, V<sub>IL</sub> = 0.5V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at 3V and T<sub>A</sub> = +25°C.)  
(Notes 3, 4)

| PARAMETER                                    | SYMBOL                                         | CONDITIONS                                                                      | T <sub>A</sub>                       | MIN | TYP  | MAX | UNITS |
|----------------------------------------------|------------------------------------------------|---------------------------------------------------------------------------------|--------------------------------------|-----|------|-----|-------|
| Turn-Off Time (Note 7)                       | t <sub>OFF</sub>                               | V <sub>NO</sub> or V <sub>NC</sub> = 1.5V, Figure 2                             | +25°C                                |     | 10   | 12  | ns    |
|                                              |                                                |                                                                                 | T <sub>MIN</sub> to T <sub>MAX</sub> |     |      | 15  |       |
| Break-Before-Make<br>(MAX4688 only) (Note 7) | t <sub>BBM</sub>                               | V <sub>NO</sub> , V <sub>NC</sub> = 1.5V, Figure 3                              | +25°C                                |     | 8    |     | ns    |
|                                              |                                                |                                                                                 | T <sub>MIN</sub> to T <sub>MAX</sub> | 2   |      |     |       |
| Charge Injection                             | Q                                              | V <sub>GEN</sub> = 0, R <sub>GEN</sub> = 0,<br>C <sub>L</sub> = 1.0nF, Figure 4 | +25°C                                |     | 40   |     | pC    |
| On-Channel -3dB<br>Bandwidth                 | BW                                             | Signal = 0dBm, 50Ω in and out,<br>Figure 5                                      | +25°C                                |     | 200  |     | MHz   |
| Off-Isolation (Note 8)                       | V <sub>ISO</sub>                               | C <sub>L</sub> = 5pF, R <sub>L</sub> = 50Ω, f = 100kHz,<br>Figure 5             | +25°C                                |     | -90  |     | dB    |
| Crosstalk (MAX4688<br>only) (Note 9)         | V <sub>CR</sub>                                | C <sub>L</sub> = 5pF, R <sub>L</sub> = 50Ω, f = 100kHz,<br>Figure 5             | +25°C                                |     | -95  |     | dB    |
| Total Harmonic<br>Distortion                 | THD                                            | R <sub>L</sub> = 600Ω, 2Vp-p, f = 20Hz to 20kHz                                 | +25°C                                |     | 0.06 |     | %     |
| NO, NC Off-<br>Capacitance                   | C <sub>NO(OFF)</sub> ,<br>C <sub>NC(OFF)</sub> | f = 1MHz, Figure 6                                                              | +25°C                                |     | 12   |     | pF    |
| COM Off-Capacitance                          | C <sub>COM(OFF)</sub>                          | f = 1MHz, Figure 6                                                              | +25°C                                |     | 12   |     | pF    |
| Switch On-Capacitance                        | C <sub>(ON)</sub>                              | f = 1MHz, Figure 6                                                              | +25°C                                |     | 35   |     | pF    |
| <b>DIGITAL I/O</b>                           |                                                |                                                                                 |                                      |     |      |     |       |
| Input Logic High                             | V <sub>IH</sub>                                |                                                                                 | T <sub>MIN</sub> to T <sub>MAX</sub> | 1.4 |      |     | V     |
| Input Logic Low                              | V <sub>IL</sub>                                |                                                                                 | T <sub>MIN</sub> to T <sub>MAX</sub> |     |      | 0.5 | V     |
| Logic Input<br>Leakage Current               | I <sub>IH</sub> , I <sub>IL</sub>              | V <sub>IN</sub> = 0 or V <sub>+</sub>                                           | T <sub>MIN</sub> to T <sub>MAX</sub> | -1  |      | 1   | μA    |
| <b>POWER SUPPLY</b>                          |                                                |                                                                                 |                                      |     |      |     |       |
| Power-Supply Range                           | V <sub>+</sub>                                 |                                                                                 | T <sub>MIN</sub> to T <sub>MAX</sub> | 1.8 |      | 5.5 | V     |
| Supply Current                               | I <sub>+</sub>                                 | V <sub>+</sub> = 3.3V, V <sub>IN</sub> = 0 or V <sub>+</sub>                    | T <sub>MIN</sub> to T <sub>MAX</sub> | -1  |      | 1   | μA    |

**Note 3:** The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet.

**Note 4:** UCSP parts are 100% tested at +25°C only and guaranteed by correlation at the full hot-rated temperature.

**Note 5:** ΔRON = RON(MAX) - RON(MIN), between switches.

**Note 6:** Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

**Note 7:** Guaranteed by design.

**Note 8:** Off Isolation = 20log<sub>10</sub> (V<sub>COM</sub> / V<sub>NO</sub>), V<sub>COM</sub> = output, V<sub>NO</sub> = input to off switch.

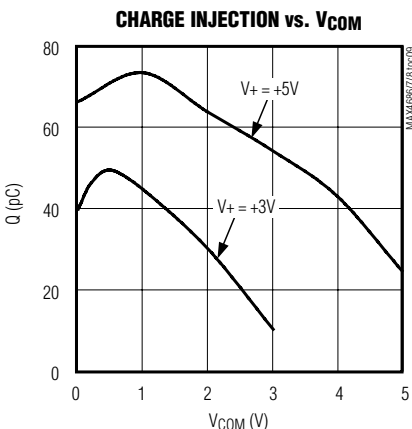
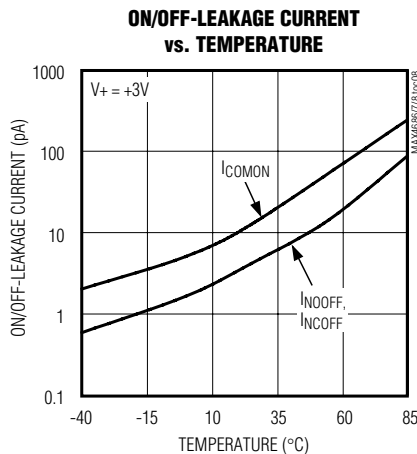
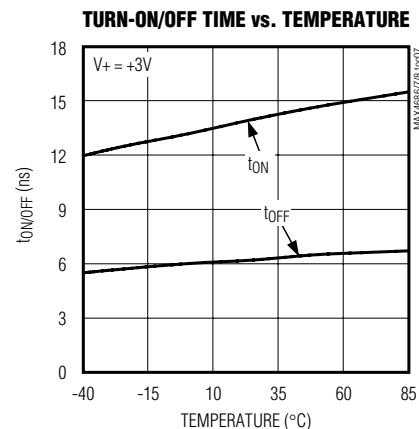
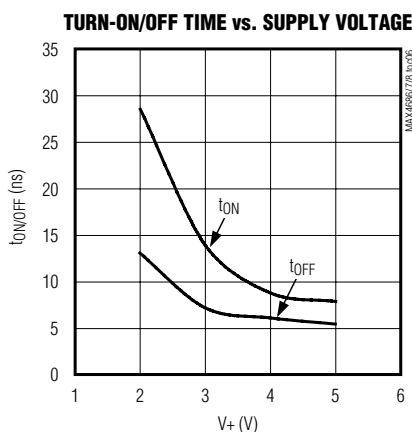
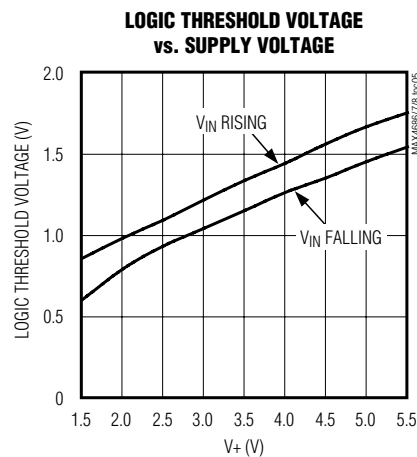
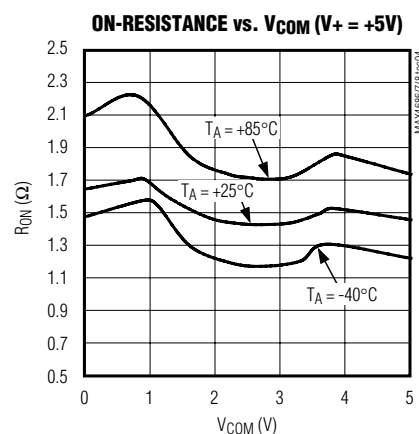
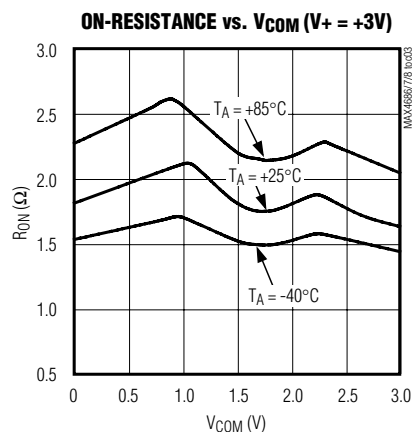
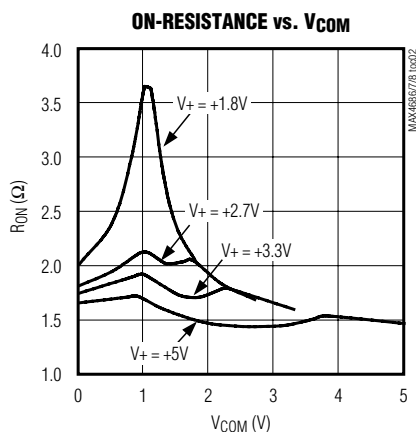
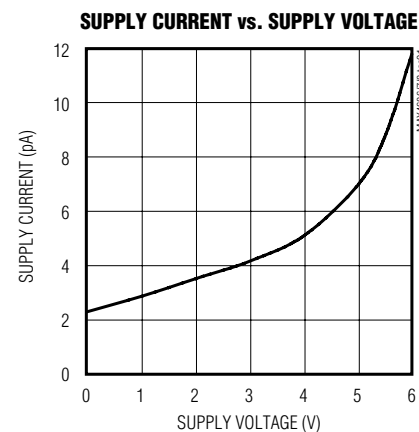
**Note 9:** Between switches.

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# 2.5 $\Omega$ , Low-Voltage, SPST/SPDT Analog Switches in UCSP Package

## Typical Operating Characteristics

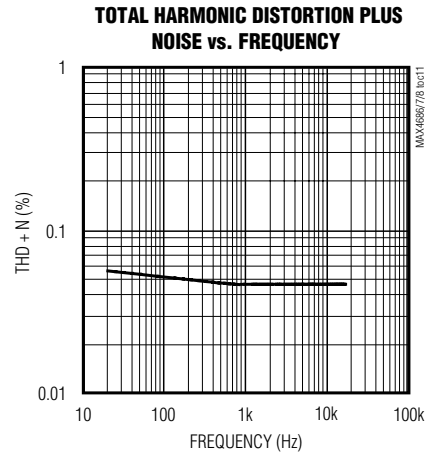
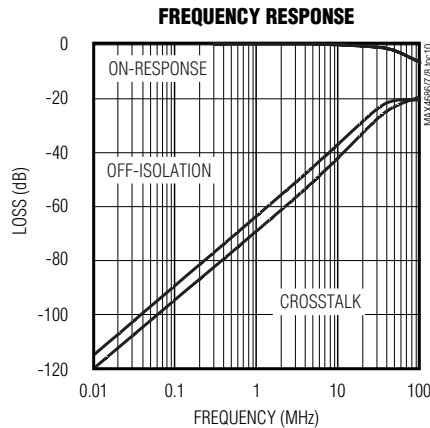
( $T_A = +25^\circ\text{C}$ , unless otherwise noted.)



# 2.5Ω, Low-Voltage, SPST/SPDT Analog Switches in UCSP Package

## Typical Operating Characteristics (continued)

(T<sub>A</sub> = +25°C, unless otherwise noted.)



## Pin Description

| BUMP    |         |         | NAME | FUNCTION                                |
|---------|---------|---------|------|-----------------------------------------|
| MAX4686 | MAX4687 | MAX4688 |      |                                         |
| B1      | B1      | B1      | V+   | Positive Supply Voltage Input           |
| B2      | B2      | B2      | IN   | Digital Control Input                   |
| B3      | B3      | B3      | GND  | Ground                                  |
| —       | A1      | A3      | NC   | Analog Switch, Normally Closed Terminal |
| A3      | A3      | A2      | COM  | Analog Switch, Common Terminal          |
| A1      | —       | A1      | NO   | Analog Switch, Normally Open Terminal   |
| A2      | A2      | —       | I.C. | Internally Connected                    |

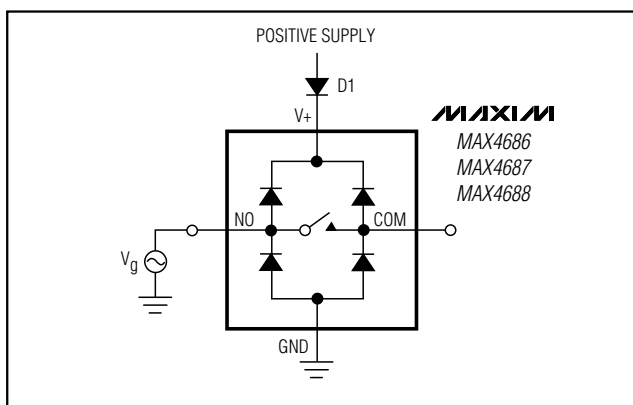


Figure 1. Overvoltage Protection Using External Blocking Diodes

## Applications Information

### Logic Inputs

Where the MAX4686/MAX4687/MAX4688 have a +3.3V supply, IN may be driven low to GND and driven high to 5.5V. Driving IN rail-to-rail minimizes power consumption. Logic inputs accept up to +5.5V regardless of supply voltage.

### Analog Signal Levels

Analog signals that range over the entire supply voltage (V+ to GND) are passed with very little change in R<sub>ON</sub> (see *Typical Operating Characteristics*). The switches are bidirectional, so the NO, NC, and COM pins are both inputs or outputs.

### Power-Supply Sequencing and Overvoltage Protection

**CAUTION:** Do not exceed the absolute maximum ratings because stresses beyond the listed ratings may cause permanent damage to devices.

## 2.5Ω, Low-Voltage, SPST/SPDT Analog Switches in UCSP Package

Proper power-supply sequencing is recommended for all CMOS devices. Always apply V+ before applying analog signals, especially if the analog signal is not current limited. If this sequencing is not possible, and if the analog inputs are not current limited to <20mA, add a small-signal diode (D1) as shown in Figure 1. Adding a protection diode reduces the analog range to a diode drop (about 0.7V) below V+ (for D1). R<sub>ON</sub> increases slightly at low supply voltages. Maximum supply voltage (V+) must not exceed +6V. Protection diode D1 also protects against some overvoltage situations. No damage will result on Figure 1's circuit if the supply voltage is below the absolute maximum rating and if a fault voltage up to the absolute maximum rating is applied to an analog signal pin.

### UCSP Package Consideration

For general UCSP package information and PC layout considerations, please refer to the Maxim Application Note (Wafer-Level Ultra-Chip-Board-Scale Package).

### UCSP Reliability

The chip-scale package (UCSP) represents a unique packaging form factor that may not perform equally to a packaged product through traditional mechanical reliability tests. CSP reliability is integrally linked to the user's assembly methods, circuit board material, and usage environment. The user should closely review these areas when considering use of a CSP package. Performance through Operating Life Test and Moisture Resistance remains uncompromised as it is primarily determined by the wafer-fabrication process.

Mechanical stress performance is a greater consideration for a CSP package. CSPs are attached through direct solder contact to the user's PC board, foregoing the inherent stress relief of a packaged product lead frame. Solder joint contact integrity must be considered. Information on Maxim's qualification plan, test data, and recommendations are detailed in the UCSP application note, which can be found on Maxim's website at [www.maxim-ic.com](http://www.maxim-ic.com).

### Test Circuits/Timing Diagrams

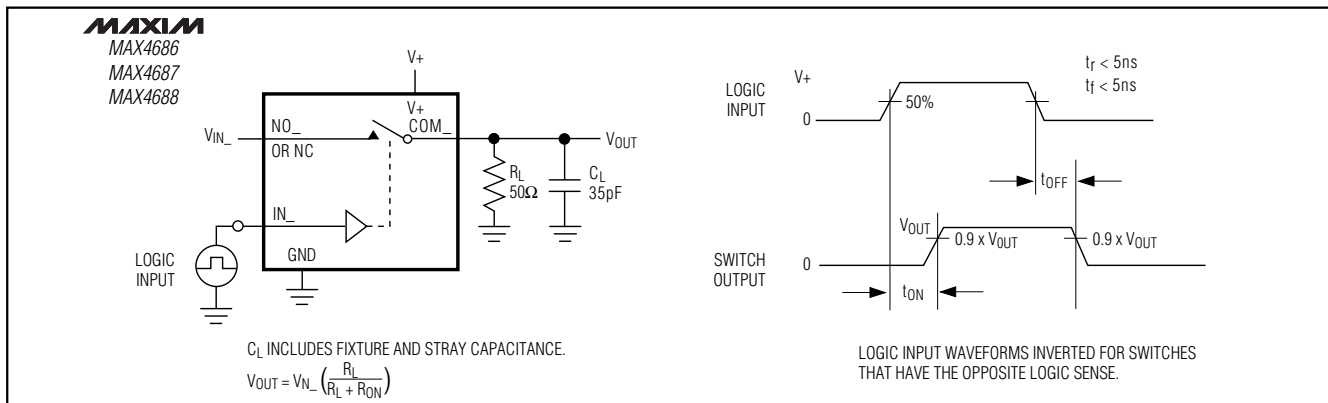


Figure 2. Switching Time

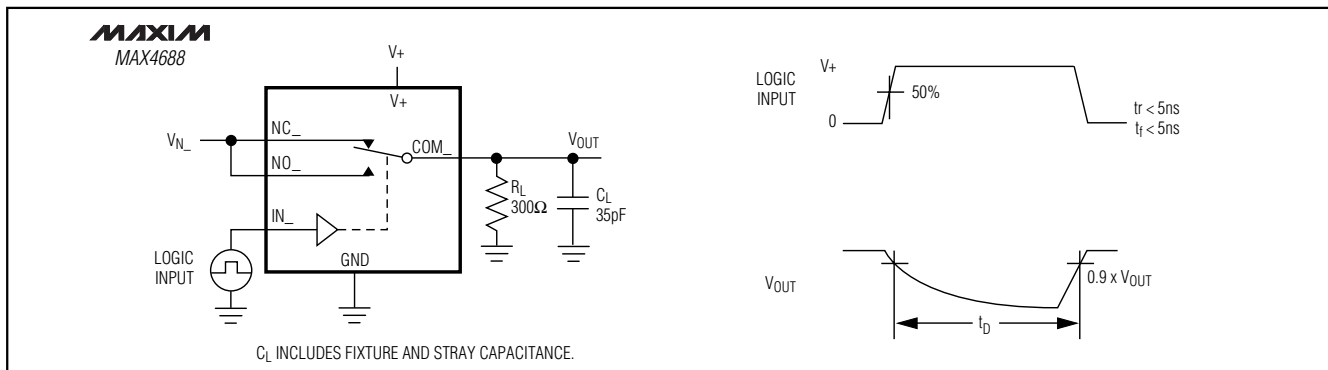


Figure 3. Break-Before-Make Interval (MAX4688 only)

# 2.5Ω, Low-Voltage, SPST/SPDT Analog Switches in UCSP Package

## Test Circuits/Timing Diagrams (continued)

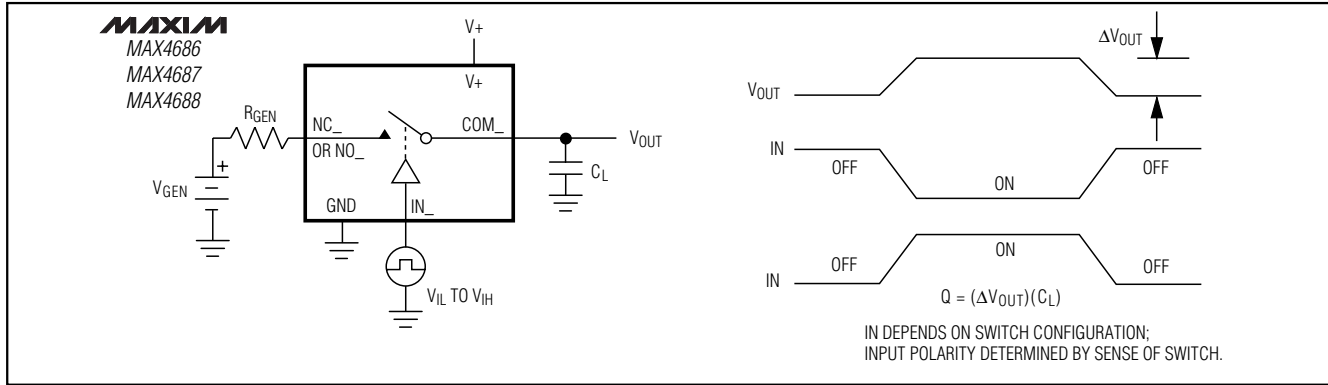


Figure 4. Charge Injection

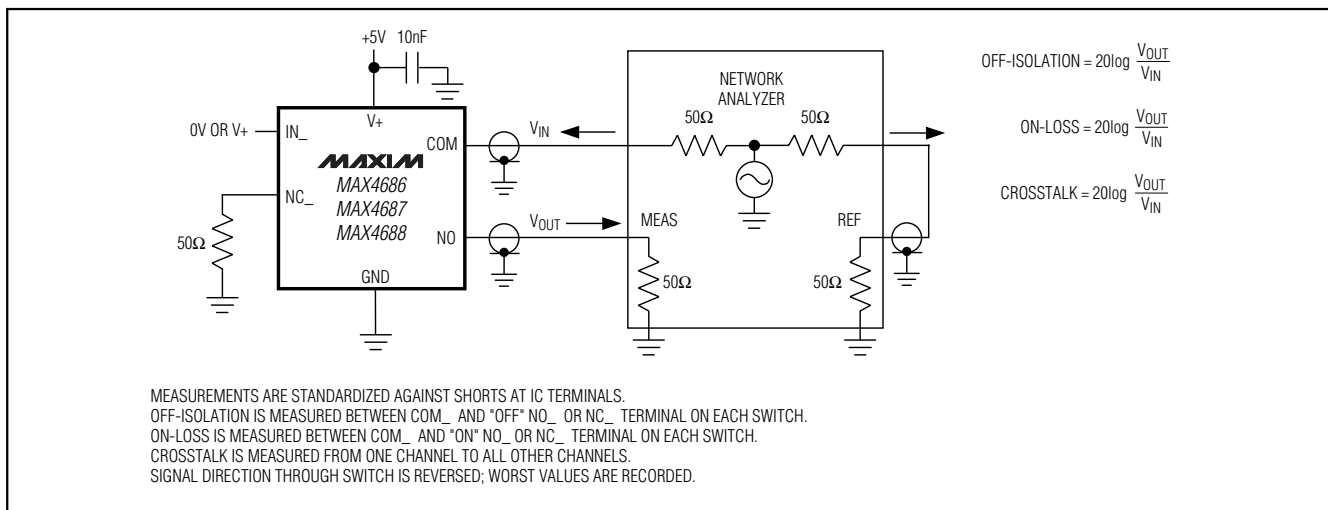


Figure 5. Off-Isolation/On-Channel Bandwidth, Crosstalk

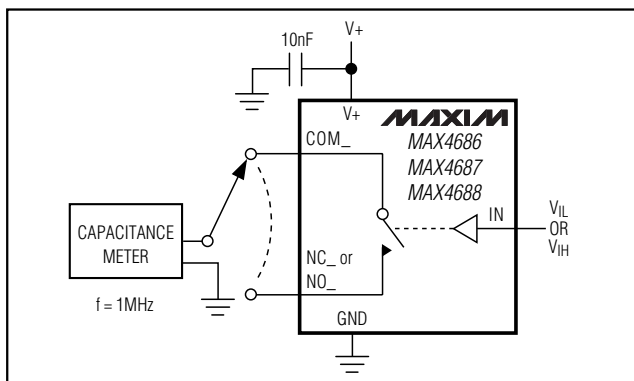


Figure 6. Channel Off/On-Capacitance

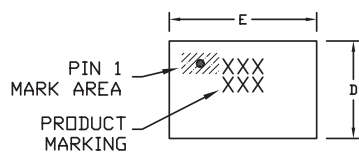
## Chip Information

TRANSISTOR COUNT: 150

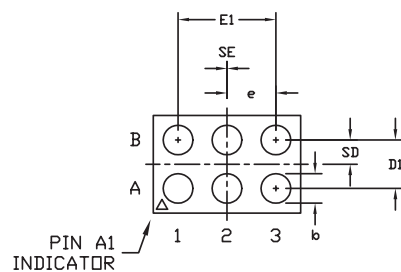
# 2.5Ω, Low-Voltage, SPST/SPDT Analog Switches in UCSP Package

## Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).



TOP VIEW

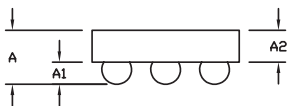


BOTTOM VIEW

| COMMON DIMENSIONS |             |
|-------------------|-------------|
| A                 | 0.60±0.05   |
| A1                | 0.27±0.03   |
| A2                | 0.33 REF.   |
| b                 | Ø0.37 BASIC |
| D1                | 0.50 BASIC  |
| E1                | 1.00 BASIC  |
| e                 | 0.50 BASIC  |
| SD                | 0.25 BASIC  |
| SE                | 0.00 BASIC  |

| PKG. CODE | VARIABLE DIMENSIONS |           | DEPOPULATED SOLDER BALLS |
|-----------|---------------------|-----------|--------------------------|
|           | D                   | E         |                          |
| B6-1      | 1.00±0.05           | 1.52±0.05 | NONE                     |
| B6-2      | 1.00±0.05           | 1.52±0.05 | B2                       |
| B6-3      | 1.05±0.05           | 1.57±0.05 | NONE                     |
| B6-4      | 1.05±0.05           | 1.57±0.05 | B2                       |
| B6-5      | 0.97±0.05           | 1.46±0.05 | NONE                     |
| B6-6      | 1.16±0.05           | 1.57±0.05 | NONE                     |

- NOTES:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
  2. PRODUCT MARKING: NUMBER OF CHARACTERS AND LINES VARY PER PRODUCT.



SIDE VIEW

|                           |                      |      |     |
|---------------------------|----------------------|------|-----|
| <b>MAXIM</b>              |                      |      |     |
| PROPRIETARY INFORMATION   |                      |      |     |
| TITLE:                    |                      |      |     |
| PACKAGE OUTLINE, 3x2 UCSP |                      |      |     |
| APPROVAL                  | DOCUMENT CONTROL NO. | REV. | 1/1 |
|                           | 21-0097              | F    |     |

6L, UCSP:EPS

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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